

Part Number : 716607040

Product Description : 1.27mm Pitch EBBI 50D Receptacle, Vertical, Blind Mate, 40 Circuits, 2.79mm PC Tail Length Status : New Business Not Supported

Series Number : 71660 Product Category : PCB Headers and Receptacles

Documents & Resources

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	(
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)8585-DC (23 Jan 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	New Business Not Supported
Category	PCB Headers and Receptacles
Series	71660

Description	1.27mm Pitch EBBI 50D Receptacle, Vertical, Blind Mate, 40 Circuits, 2.79mm PC Tail Length
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Family	EBBI 50D Connector System
Product Name	EBBI
UPC	800754250641

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	30V

Physical

Circuits (Loaded)	40
Circuits (maximum)	40
Color - Resin	Black
Durability (mating cycles max)	2000
Flammability	94V-0
Glow-Wire Capable	No
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Material - Resin Net Weight	High Temperature Thermoplastic 2.385/g
Net Weight	2.385/g
Net Weight Number of Rows	2.385/g 2
Net Weight Number of Rows Orientation	2.385/g 2 Vertical
Net Weight Number of Rows Orientation Packaging Type	2.385/g 2 Vertical Tray
Net Weight Number of Rows Orientation Packaging Type PC Tail Length	2.385/g 2 Vertical Tray 2.79mm

Pitch - Mating Interface	1.27mm
Plating min - Mating	0.762µm
Plating min - Termination	0.254µm
Polarized to PCB	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Lead-Free Process Capability	SMC&WAVE
Max-Temp	260

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